



Application No.10/632,568  
Attorney Docket: CPAC 1017-3 D1

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Paula Faulk Hurley

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

|   |                                     |
|---|-------------------------------------|
| In re application of: Marcos Karnezos   | Attorney Docket No.: CPAC 1017-3 D1 |
| Application No.: 10/632,568   | Examiner: Douglas M. Menz           |
| Filed: 02 August 2003   | Group: 2891                         |
| Title: Semiconductor Multi-Package Module<br>Having Wire Bond Interconnect Between Stacked<br>Packages And Having Enhanced Heat Dissipation | Confirmation No.: 2603              |
|   | Customer No. 22470                  |

**INFORMATION DISCLOSURE STATEMENT**

Mail Stop Amendment  
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Alexandria, VA 22313-1450

Sir:

It is requested that the information identified in this statement be considered by the Examiner and made of record in the above-identified application. This statement is not intended to represent that a search has been made or that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 C.F.R. 1.56.

Enclosed with this statement is a Form PTO/SB/08A. The Examiner is requested to initial the form and return it to the undersigned in accordance with M.P.E.P. 609.

Also enclosed with this statement is a copy of each cited document as required by 37 C.F.R. 1.98. However, since this application was filed after June 30, 2003, copies of U. S. Patents and U. S. Patent Application Publications are not enclosed. (See O. G. Notice of August 5, 2003.)

This statement should be considered under 37 C.F.R. 1.97(c) because it is being filed before the mailing date of a FINAL office action, a Notice of Allowance, or an action that

otherwise closes prosecution in the subject application, whichever occurs first, AND:  
This statement is accompanied by the \$180 fee set forth in 37 C.F.R. 1.17(p).

***Fee Authorization.*** The Commissioner is hereby authorized to charge any additional fees or credit any overpayment associated with this communication to Deposit Account No. 50-0869 (CPAC 1017-3 D1). A duplicate copy of this authorization is enclosed.

Respectfully submitted,  
Haynes Beffel & Wolfeld LLP

Date: 10 January 2006

By: \_\_\_\_\_

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PTO/SB/08A (08-00)  
Approved for use through 10/31/2002. OMB 0651-0031  
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| <b>INFORMATION DISCLOSURE<br/>STATEMENT BY APPLICANT</b><br><br>(use as many sheets as necessary) |   |    | <b>Complete if Known</b> |                        |                |
|   |   |    | Application Number       | 10/632,568             |                |
|   |   |    | Filing Date              | 08/02/03               |                |
|   |   |    | First Named Inventor     | Kamezos                |                |
|   |   |    | Group Art Unit           | 2891                   |                |
|   |   |    | Examiner Name            | Douglas M. Menz        |                |
| Sheet   | 1 | of | 1                        | Attorney Docket Number | CPAC 1017-3 D2 |

| U.S. PATENT DOCUMENTS             |                          |                      |                                      |  |  |  |
|-----------------------------------|--------------------------|----------------------|--------------------------------------|--|--|--|
| Examiner<br>Initials <sup>1</sup> | Cite<br>No. <sup>1</sup> | U.S. Patent Document |                                      | Name of Patentee or Applicant<br>of Cited Document | Date of Publication of<br>Cited Document<br>MM-DD-YYYY | Pages, Columns, Lines,<br>Where Relevant<br>Passages or Relevant<br>Figures Appear |
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|                                   | A19                      |                      |                                      |  |  |  |
|                                   | A20                      |                      |                                      |  |  |  |

| FOREIGN PATENT DOCUMENTS |                          |                         |                     |                                      |  |  |  |                |
|--------------------------|--------------------------|-------------------------|---------------------|--------------------------------------|--|--|--|----------------|
| Examiner<br>Initials*    | Cite<br>No. <sup>1</sup> | Foreign Patent Document |                     |                                      | Name of Patentee or<br>Applicant of Cited Document | Date of Publication of<br>Cited Document<br>MM-DD-YYYY | Pages, Columns, Lines,<br>Where Relevant<br>Passages or Relevant<br>Figures Appear | T <sup>6</sup> |
|                          |                          | Office <sup>3</sup>     | Number <sup>4</sup> | Kind Code <sup>5</sup><br>(if known) |  |  |  |                |
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|                          | B6                       |                         |                     |                                      |  |  |  |                |
|                          | B7                       |                         |                     |                                      |  |  |  |                |
|                          | B8                       |                         |                     |                                      |  |  |  |                |
|                          | B9                       |                         |                     |                                      |  |  |  |                |
|                          | B10                      |                         |                     |                                      |  |  |  |                |

|                       |  |                    |  |
|-----------------------|--|--------------------|--|
| Examiner<br>Signature |  | Date<br>Considered |  |
|-----------------------|--|--------------------|--|

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup> Unique citation designation number. <sup>2</sup> See attached Kinds of U.S. Patent Documents. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

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